















Revision of Sep. 2023

# AirMatrix<sup>®</sup> Surface Mount Fuses MF Series, 2410 Size



## **Clearing Time Characteristics:**

% of Current Rating	Clearing Time at 25°C		
% of current Kating	Min.	Max.	
125%	1 hour		
200%		120 seconds	
1000%	0.001 seconds	0.01 seconds	

## **Application Fields:**

- Power tools
- DC-DC convert
- Power adapter
- **Panel**
- Server
- Battery pack
- Medical
- Lighting
- **Industrial Equipment**
- White Goods

## **Agency Approval:**

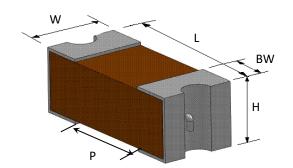
Agency	File No.	
UL	E232989	
cqc	CQC11012065956	
KC	SU05038-12001/12002	
PSE	JD 60130890	
VDE	40034853	

#### **Features:**

- Extremely small size with 250 VAC rating
- Surface mount fuses in AC applications
- Excellent inrush current withstanding capability
- Fiberglass enforced epoxy fuse body
- Copper termination with nickel and tin plating
- 100% lead-free
- Operating temperature range: -55°C to +125 °C (with de-rating)
- Compliant with IEC 60127-4

## **Shape and Dimensions:**

	Inch	mm
L	0.240 ± 0.006	6.10 ± 0.15
W	0.098 ± 0.006	2.49 ± 0.15
Н	0.085 ± 0.008	2.16 ± 0.20
BW	0.053 ± 0.015	1.35 ± 0.38
Р	≥ 0.118	≥ 3.00















# **Ordering Information:**

Part Number	Current Rating (A)	Voltage Rating (Vac)	Interrupting Ratings	Nominal Cold DCR $(\Omega)^1$	Voltage Drop Max. (mV) <sup>2</sup>	Nominal I <sup>2</sup> t (A <sup>2</sup> s) <sup>3</sup>	Marking ( Black )
MF2410F0.500TM	0.50	250		0.206	166	0.11	С
MF2410F0.630TM	0.63	250		0.148	144	0.20	S
MF2410F0.800TM	0.80	250		0.109	139	0.35	Н
MF2410F1.000TM	1.00	250	100A @ 250Vac	0.084	129	0.62	E
MF2410F1.250TM	1.25	250	200100	0.065	128	1.00	F
MF2410F1.600TM	1.60	250		0.049	127	1.80	Т
MF2410F2.000TM	2.00	250		0.038	123	3.00	I

#### Notes:

- 1. Resistance is measured at  $\leq$ 10% of rated current and 25  $^{\circ}$ C ambient.
- 2. Voltage drop is measured at 100% of rated current.
- 3. Melting l<sup>2</sup>t is calculated at 0.001 second pre-arcing time.











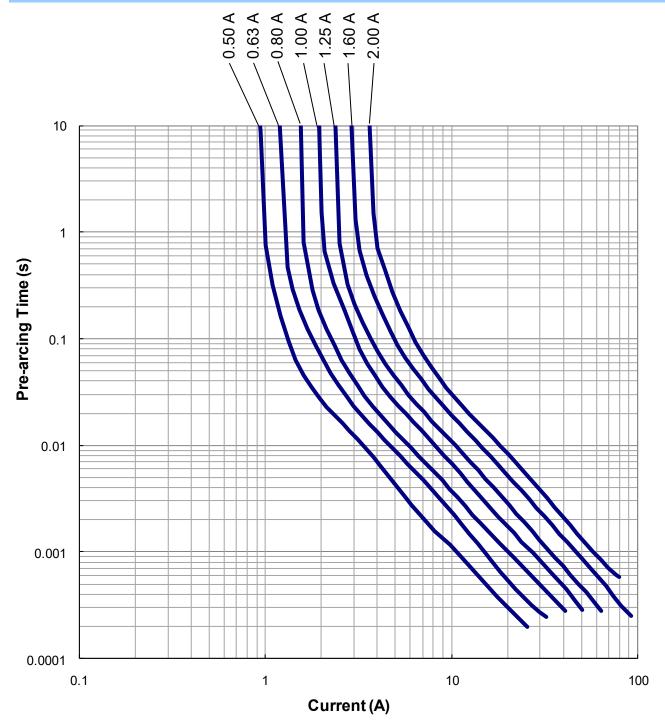






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## **Average Pre-arcing Time Curves:**











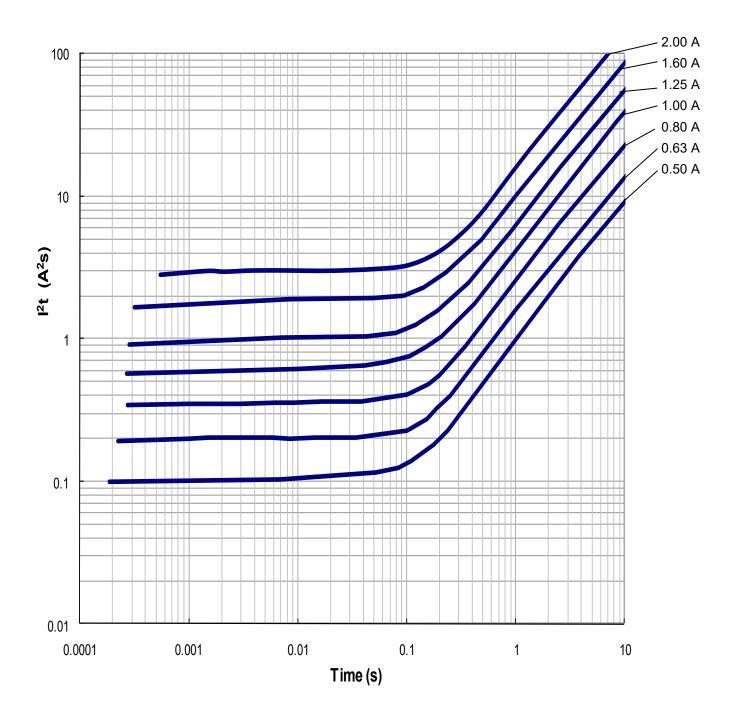








# Average I<sup>2</sup>t vs. t Curves:











# AirMatrix<sup>®</sup> Surface Mount Fuses

#### **Product Identification:**

MF 2410 F 0.500 T M -7

(1) (2) (3) (4) (5) (6) (5)

(1) Series Code: MF—MF Series

(2) Size Code: Standard EIA Chip Sizes

(3) Time/Current Characteristic: F

(4) Current Rating: 0.500—0.5A

(5) Package Code: T - Tape & Reel, B - Bulk

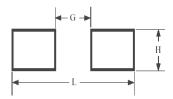
No suffix after M: - 2K Tape & Reel

With suffix -7 after M: - 7K Tape & Reel

(6) Marketing Code: M-With Marking

#### **Recommended Land Pattern:**

	MF2410		
	Inch	mm	
L	0.338	8.60	
G	0.118	3.00	
Н	0.110	2.80	



#### Packaging:

Chip Size	Parts on 7 inch (178 mm) Reel	Parts on 13 inch (330 mm) Reel	
2410 (6125)	2,000	7,000	

### Storage:

The maximum ambient temperature shall not exceed  $35^{\circ}$ C . Storage temperatures higher than  $35^{\circ}$ C could result in the deformation of packaging materials.

The maximum relative humidity recommended for storage is 75%. High humidity with high temperature can accelerate the oxidation of the solder plating on the termination and reduce the solderability of the components.

Sealed vacuum foil bags with desiccant should only be opened prior to use.

The products should not be stored in areas where harmful gases containing sulfur or chlorine are present.









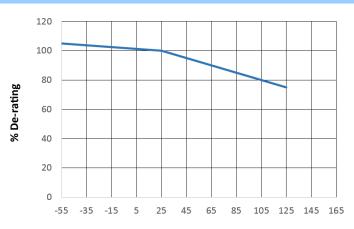
# AirMatrix<sup>®</sup> Surface Mount Fuses

## **Fuse Selection and Temperature De-rating Guideline:**

The ambient temperature affects the current carrying capacity of fuses. When a fuse is operating at a temperature higher than 25°C, the fuse shall be "de-rated".

To select a fuse from the catalog, the following rule may be followed:

Catalog Fuse Current Rating = Nominal Operating Current / 0.75 / % De-rating at the maximum operating temperature. Example: At maximum operating temperature of  $65^{\circ}$ C, % De-rating is 90%. The nominal operating current is 4 A. The current rating for fuse selected from the catalog shall be: 4/0.75/90% = 5.9 or 6.3 A.



Maximum Operating Temperature (°C)

## **Environmental Tests:**

No.	Reliability Test	Test Condition and Requirement	Test Reference
1	Bend	2 mm bend, DCR change within ±20% (±10% for≤1A), no mechanical damage.	IEC60068-2-21
2	Solderability	245°C , 5 seconds, new solder coverage ≥95%	MIL-STD-202 Method 208
3	Soldering Heat Resistance	260°C, 10 seconds, 20% DCR change max. (10% for $\leq$ 1 A), new solder coverage 75% minimum	MIL-STD-202 Method 210
4	Life	80% rated current (75% for <1A), 2000 hours, ambient temperature (from +20°C to 30°C), voltage drop change within $\pm 10\%$	Refer to AEM QIQ106
5	Thermal Shock	-65°C to +125°C, 100 cycles, DCR change ≤ ±10%, no mechanical damage	MIL-STD-202 Method 107
6	Mechanical Vibration	$5-3000$ Hz, 0.4 inch double amplitude or 30 G peak, DCR change $\leq \pm 10\%$ , no mechanical damage	MIL-STD-202 Method 204
7	Mechanical Shock	1500 G, 0.5 milliseconds, half-sine shocks, DCR change ≤ ±10%, no mechanical damage	MIL-STD-202 Method 213
8	Salt Spray	5% salt solution, 48 hour exposure, DCR change ≤ ±10%, no excessive corrosion	MIL-STD-202 Method 101
9	Moisture Resistance	10 cycles, DCR change ≤ ±10%, no excessive corrosion	MIL-STD-202 Method 106

Moisture Sensitivity Level 1





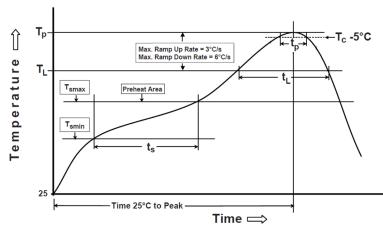




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## **Soldering Temperature Profile:**

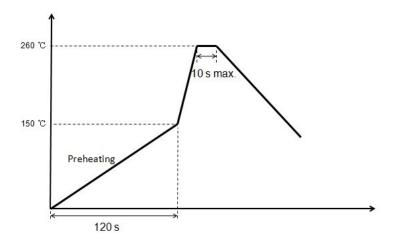
\* Recommended Temperature Profile for Reflow Soldering



Profile Feature	Pb-Free Assembly	
Preheat/Soak		
Temperature Min (T <sub>smin</sub> )	150°C	
Temperature Max(T <sub>smax</sub> )	200°C	
Ramp-uprate (T <sub>L</sub> to T <sub>p</sub> )	3°C/second max.	
Liquidous temperature(T <sub>L</sub> )	217°C	
Time( $t_L$ ) maintained above $T_L$	60~150 seconds	
Peak package body temperature (T <sub>p</sub> )	260°C	
Time $(t_p)^*$ within 5°C of the specified classification temperature $(T_c)$	30 seconds *	
Ramp-down rate (Tp to Tl)	6°C/second max.	
Time 25°C to peak temperature	8 minutes max.	
* Tolerance for peak profile temperature (T <sub>a</sub> ) is defined as a		

<sup>\*</sup> Tolerance for peak profile temperature  $(T_p)$  is defined as a supplier minimum and a user maximum

<sup>\*</sup> Recommended Temperature Profile for Wave Soldering











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